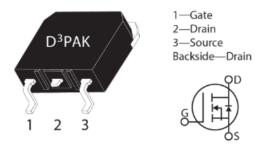


MSC017SMA120S Silicon Carbide N-Channel Power MOSFET

Product Overview

The silicon carbide (SiC) power MOSFET product line from Microsemi increases the performance over silicon MOSFET and silicon IGBT solutions while lowering the total cost of ownership for high-voltage applications. The MSC017SMA120S device is a 1200 V, 17 m Ω SiC MOSFET in a TO-268 (D3PAK) package.



Features

The following are key features of the MSC017SMA120S device:

- Low capacitances and low gate charge
- Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T_{J(max)} = 175 °C
- · Fast and reliable body diode
- Superior avalanche ruggedness
- RoHS compliant

Benefits

The following are benefits of the MSC017SMA120S device:

- High efficiency to enable lighter, more compact system
- Simple to drive and easy to parallel
- Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- Lower system cost of ownership

Applications

The MSC017SMA120S device is designed for the following applications:

- PV inverter, converter, and industrial motor drives
- Smart grid transmission and distribution
- · Induction heating and welding
- H/EV powertrain and EV charger
- Power supply and distribution



Device Specifications

This section shows the specifications of the MSC017SMA120S device.

Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC017SMA120S device.

Table 1 • Absolute Maximum Ratings

| Symbol | Parameter | Ratings | Unit |
|------------------|---|-----------|------|
| V _{DSS} | Drain source voltage | 1200 | V |
| I _D | Continuous drain current at T _C = 25 °C | 100 | А |
| | Continuous drain current at T _C = 100 °C | 71 | |
| I _{DM} | Pulsed drain current ¹ | 280 | |
| V _{GS} | Gate-source voltage | 23 to -10 | V |
| P _D | Total power dissipation at T _C = 25 °C | 357 | w |
| | Linear derating factor | 3.33 | W/°C |

Note:

1. Repetitive rating: pulse width and case temperature limited by maximum junction temperature.

The following table shows the thermal and mechanical characteristics of the MSC017SMA120S device.

Table 2 • Thermal and Mechanical Characteristics

| Symbol | Characteristic | Min | Тур | Max | Unit |
|------------------|---|-----|------|------|------|
| R _{ÐJC} | Junction-to-case thermal resistance | | 0.28 | 0.42 | °C/W |
| T _J | Operating junction temperature | -55 | | 175 | °C |
| T _{STG} | Storage temperature | -55 | | 150 | |
| TL | Soldering temperature for 10 seconds (1.6 mm from case) | | | 300 | |
| Wt | Package weight | | 0.14 | | OZ |
| | | | 4.0 | | g |



Electrical Performance

The following table shows the static characteristics of the MSC017SMA120S device. T_J = 25 °C unless otherwise specified.

Table 3 • Static Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|--------------------------------|---|--|------|------|------|-------|
| V _{(BR)DSS} | Drain-source breakdown voltage | $V_{GS} = 0 \text{ V, I}_{D} = 100 \mu\text{A}$ | 1200 | | | V |
| R _{DS(on)} | Drain-source on resistance ¹ | V _{GS} = 20 V, I _D = 40 A | | 17.6 | 22 | mΩ |
| V _{GS(th)} | Gate-source threshold voltage | $V_{GS} = V_{DS}, I_{D} = 4.5 \text{ mA}$ | 1.9 | 2.7 | | V |
| $\Delta V_{GS(th)}/\Delta T_J$ | Threshold voltage coefficient | $V_{GS} = V_{DS}$, $I_D = 4.5 \text{ mA}$ | | -4.6 | | mV/°C |
| I _{DSS} | Zero gate voltage drain current | V _{DS} , = 1200 V, V _{GS} = 0 V | | | 100 | μΑ |
| | | V _{DS} = 1200 V, V _{GS} = 0 V T _J = 125 °C | | | 500 | - |
| I _{GSS} | Gate-source leakage current | V _{GS} = 20 V/–10 V | | | ±100 | nA |

Note:

1. Pulse test: pulse width $< 380 \mu s$, duty cycle < 2%.

The following table shows the dynamic characteristics of the MSC017SMA120S device. $T_J = 25$ °C unless otherwise specified.

Table 4 • Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|------------------------------|--|-----|------|-----|------|
| C _{iss} | Input capacitance | V _{GS} = 0 V, V _{DD} = 1000 V V _{AC} = 25 mV, f = 1 MHz | | 5280 | | pF |
| C _{rss} | Reverse transfer capacitance | VAC 25, 1 | | 12 | | |
| C _{oss} | Output capacitance | | | 265 | | |
| Q _g | Total gate charge | $V_{GS} = -5 \text{ V/20 V, } V_{DD} = 800 \text{ V}$ $I_D = 40 \text{ A}$ | | 249 | | nC |
| Q_{gs} | Gate-source charge | | | 63 | | |
| Q_{gd} | Gate-drain charge | | | 32 | | |
| t _{d(on)} | Turn-on delay time | $V_{DD} = 800 \text{ V}, V_{GS} = -5 \text{ V}/20 \text{ V},$ $I_D = 50 \text{ A}, R_{g(ext)} = 4.0 \Omega,$ | | 52 | | ns |
| t _f | Voltage fall time | Freewheeling diode = $MSC017SMA120S (V_{GS} = -5 V)$ | | 21 | | |
| t _{d(off)} | Turn-off delay time | | | 49 | | |



| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|--------------------------------|---|-----|------|-----|------|
| t _r | Voltage rise time | | | 16 | | |
| E _{on} | Turn-on switching energy | | | 1677 | | μЈ |
| E _{off} | Turn-off switching energy | | | 395 | | |
| t _{d(on)} | Turn-on delay time | V _{DD} = 800 V, V _{GS} = -5 V/20 V, | | 49 | | ns |
| t _f | Voltage fall time | $I_D = 50 \text{ A}, R_{g(ext)} = 4.0 \Omega$ Freewheeling diode = MSC050SDA120B | | 19 | | |
| t _{d(off)} | Turn-off delay time | | | 49 | | |
| t _r | Voltage rise time | | | 14 | | |
| E _{on} | Turn-on switching energy | | | 1329 | | μЈ |
| E _{off} | Turn-off switching energy | | | 429 | | |
| ESR | Equivalent series resistance | f = 1 MHz, 25 mV, drain short | | 0.71 | | Ω |
| SCWT | Short circuit withstand time | V _{DS} = 960 V, V _{GS} = 20 V | | 3 | | μs |
| E _{AS} | Avalanche energy, single pulse | V _{DS} = 150 V, I _D = 30 A | | 3500 | | mJ |

The following table shows the body diode characteristics of the MSC017SMA120S device. T_J = 25 °C unless otherwise specified.

Table 5 • Body Diode Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|------------------|--------------------------|---|-----|-----|-----|------|
| V _{SD} | Diode forward voltage | I _{SD} = 40 A, V _{GS} = 0 V | | 3.5 | | V |
| | | $I_{SD} = 40 \text{ A}, V_{GS} = -5 \text{ V}$ | | 3.9 | | V |
| t _{rr} | Reverse recovery time | $I_{SD} = 50 \text{ A}, V_{GS} = -5 \text{ V},$ Drive Rg = 4 Ω | | 40 | | ns |
| Q _{rr} | Reverse recovery charge | $V_{DD} = 800 \text{ V, dl/dt} = -2500 \text{ A/}\mu\text{s}$ | | 490 | | nC |
| I _{RRM} | Reverse recovery current | | | 22 | | Α |



Typical Performance Curves

This section shows the typical performance curves of the MSC017SMA120S device.

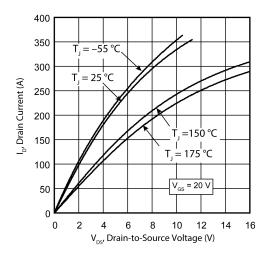


Figure 1 • Drain Current vs. V_{DS}

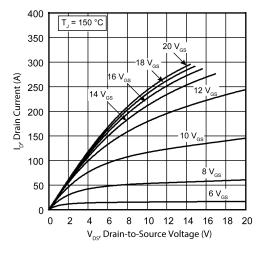


Figure 3 • Drain Current vs. V_{DS}

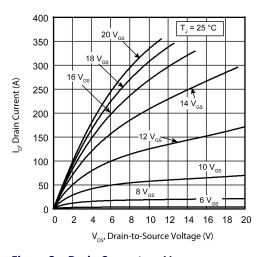


Figure 2 • Drain Current vs. V_{DS}

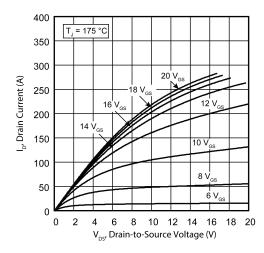


Figure 4 • Drain Current vs. V_{DS}



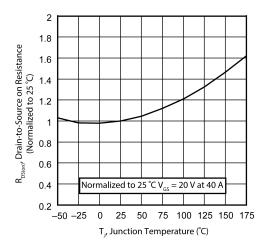


Figure 5 • RDS(on) vs. Junction Temperature

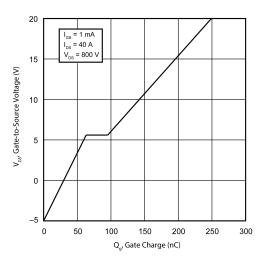


Figure 6 • Gate Charge Characteristics

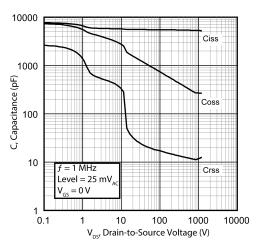


Figure 7 • Capacitance vs. Drain-to-Source Voltage

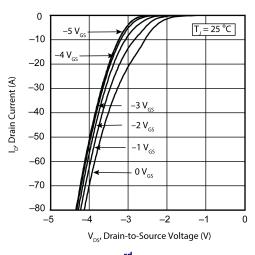


Figure 8 • I_D vs. V_{DS} 3rd Quadrant Conduction

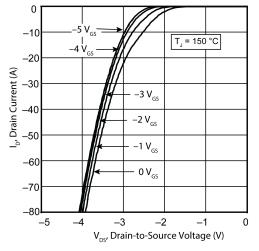


Figure 9 • I_D vs. V_{DS} 3rd Quadrant Conduction

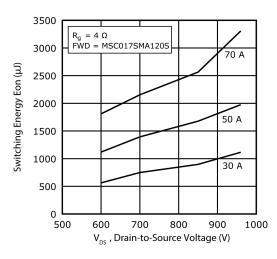


Figure 10 • Switching Energy Eon vs. V_{DS} & I_D



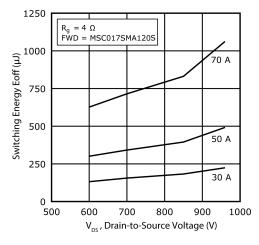


Figure 11 • Switching Energy Eoff vs. V_{DS} & I_D

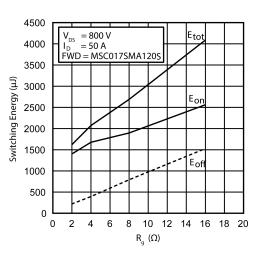


Figure 12 • Switching Energy vs. Rg

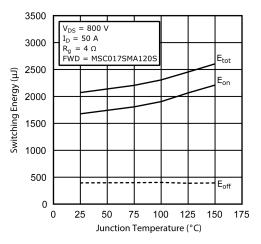


Figure 13 • Switching Energy vs. Temperature

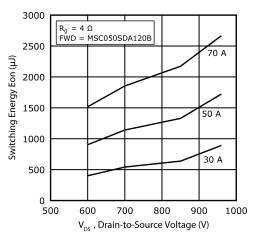


Figure 14 • Switching Energy Eon vs. V_{DS} & I_D

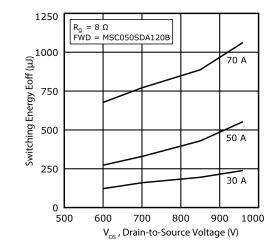


Figure 15 • Switching Energy Eoff vs. V_{DS} & I_D

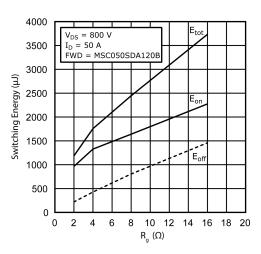
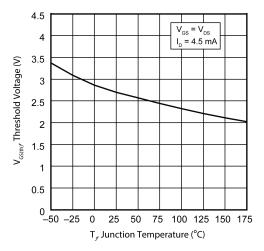


Figure 16 • Switching Energy vs. R_g





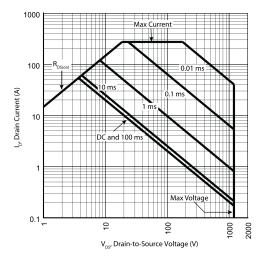


Figure 17 • Threshold Voltage vs. Junction Temp.

Figure 18 • Forward Safe Operating Area

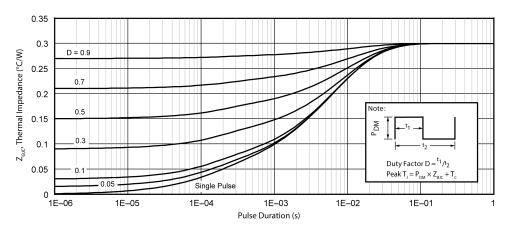


Figure 19 • Maximum Transient Thermal Impedance



Package Specification

This section shows the package specification of the MSC017SMA120S device.

Package Outline Drawing

The following figure illustrates the TO-268 package outline of the MSC017SMA120S device.

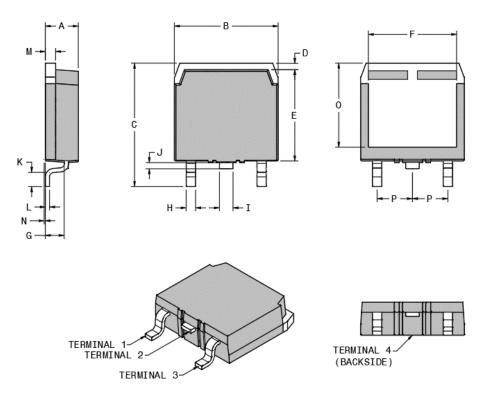


Figure 20 • Package Outline Drawing

The following table shows the TO-268 dimensions and should be used in conjunction with the package outline drawing.

Table 6 • TO-268 Dimensions

| Symbol | Min (mm) | Max (mm) | Min (in.) | Max (in.) |
|--------|----------|----------|-----------|-----------|
| А | 4.90 | 5.10 | 0.193 | 0.201 |
| В | 15.85 | 16.20 | 0.624 | 0.638 |
| С | 18.70 | 19.10 | 0.736 | 0.752 |
| D | 1.00 | 1.25 | 0.039 | 0.049 |
| Е | 13.80 | 14.00 | 0.543 | 0.551 |
| F | 13.30 | 13.60 | 0.524 | 0.535 |



| Symbol | Min (mm) | Max (mm) | Min (in.) | Max (in.) | | | |
|------------|-----------------|----------|------------------|-----------|--|--|--|
| G | 2.70 | 2.90 | 0.106 | 0.114 | | | |
| Н | 1.15 | 1.45 | 0.045 | 0.057 | | | |
| ı | 1.95 | 2.21 | 0.077 | 0.087 | | | |
| J | 0.94 | 1.40 | 0.037 | 0.055 | | | |
| К | 2.40 | 2.70 | 0.094 | 0.106 | | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | | | |
| М | 1.45 | 1.60 | 0.057 | 0.063 | | | |
| N | 0.00 | 0.18 | 0.000 | 0.007 | | | |
| 0 | 12.40 | 12.70 | 0.488 | 0.500 | | | |
| Р | 5.45 BSC (nom.) | | 0.215 BSC (nom.) | | | | |
| Terminal 1 | Gate | Gate | | | | | |
| Terminal 2 | Drain | | | | | | |
| Terminal 3 | Source | | | | | | |
| Terminal 4 | Drain | | | | | | |





Microsemi

2355 W. Chandler Blvd. Chandler, AZ 85224 USA

Within the USA: +1 (480) 792-7200 Fax: +1 (480) 792-7277

www.microsemi.com © 2020 Microsemi and its corporate affiliates. All rights reserved. Microsemi and the Microsemi logo are trademarks of Microsemi Corporation and its corporate affiliates. All other trademarks and service marks are the property of their respective owners.

Microsemi's product warranty is set forth in Microsemi's Sales Order Terms and Conditions. Information contained in this publication is provided for the sole purpose of designing with and using Microsemi products. Information regarding device applications and the like is provided only for your convenience and may be superseded by updates. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is your responsibility to ensure that your application meets with your specifications. THIS INFORMATION IS PROVIDED "AS IS." MICROSEMI MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, NON-INFRINGEMENT, MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE. IN NO EVENT WILL MICROSEMI BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL OR CONSEQUENTIAL LOSS, DAMAGE, COST OR EXPENSE WHATSOEVER RELATED TO THIS INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROSEMI HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROSEMI'S TOTAL LIABILITY ON ALL CLAIMS IN RELATED TO THIS INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, YOU PAID DIRECTLY TO MICROSEMI FOR THIS INFORMATION. Use of Microsemi devices in life support, mission-critical equipment or applications, and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend and indemnify Microsemi from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microsemi intellectual property rights unless otherwise stated.

Microsemi Corporation, a subsidiary of Microchip Technology Inc. (Nasdaq: MCHP), and its corporate affiliates are leading providers of smart, connected and secure embedded control solutions. Their easy-to-use development tools and comprehensive product portfolio enable customers to create optimal designs which reduce risk while lowering total system cost and time to market. These solutions serve more than 120,000 customers across the industrial, automotive, consumer, aerospace and defense, communications and computing markets. Headquartered in Chandler, Arizona, the company offers outstanding technical support along with dependable delivery and quality. Learn more at www.microsemi.com.

050-7781 | October 2020 | Preliminary

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

MSC017SMA120S